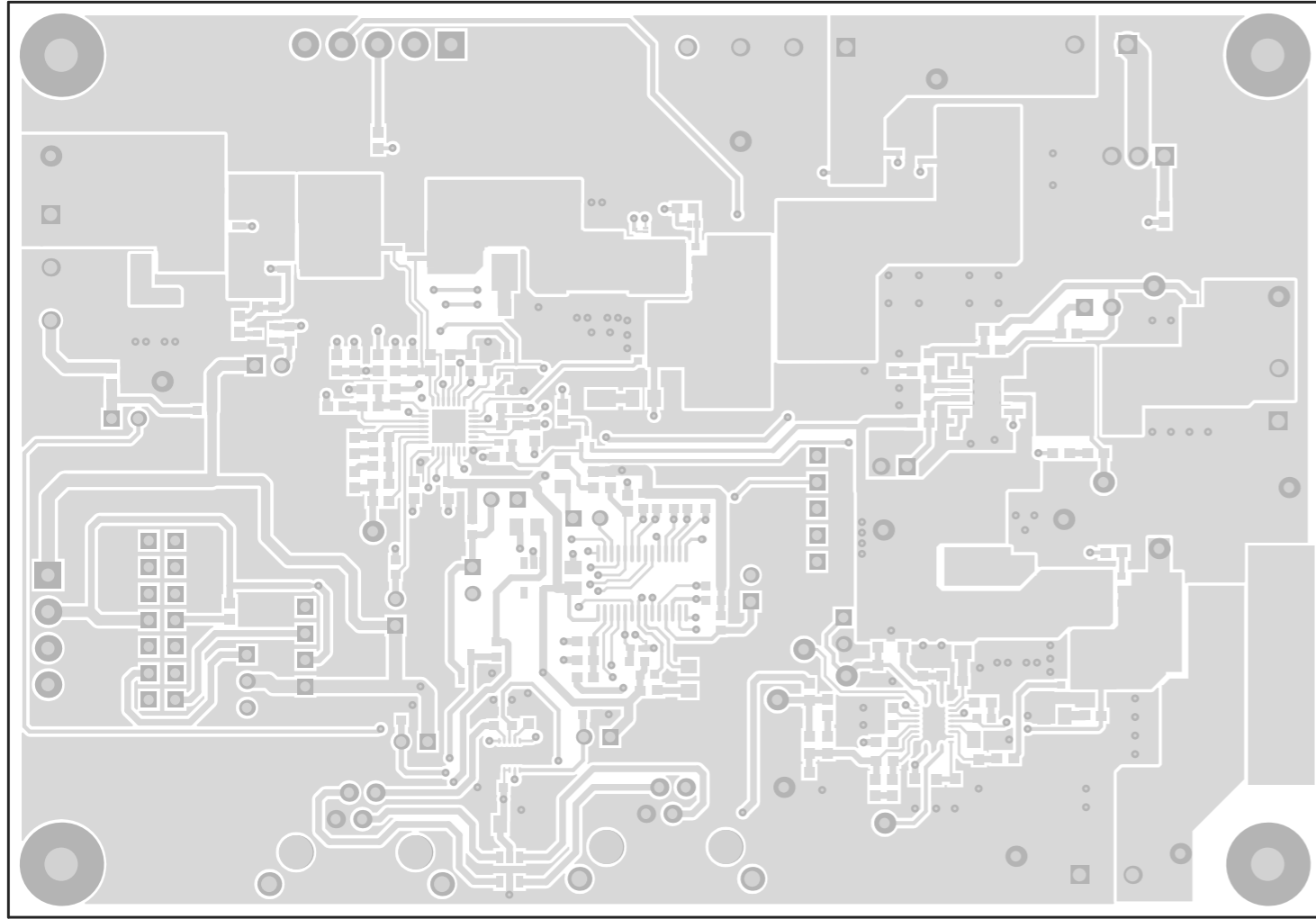
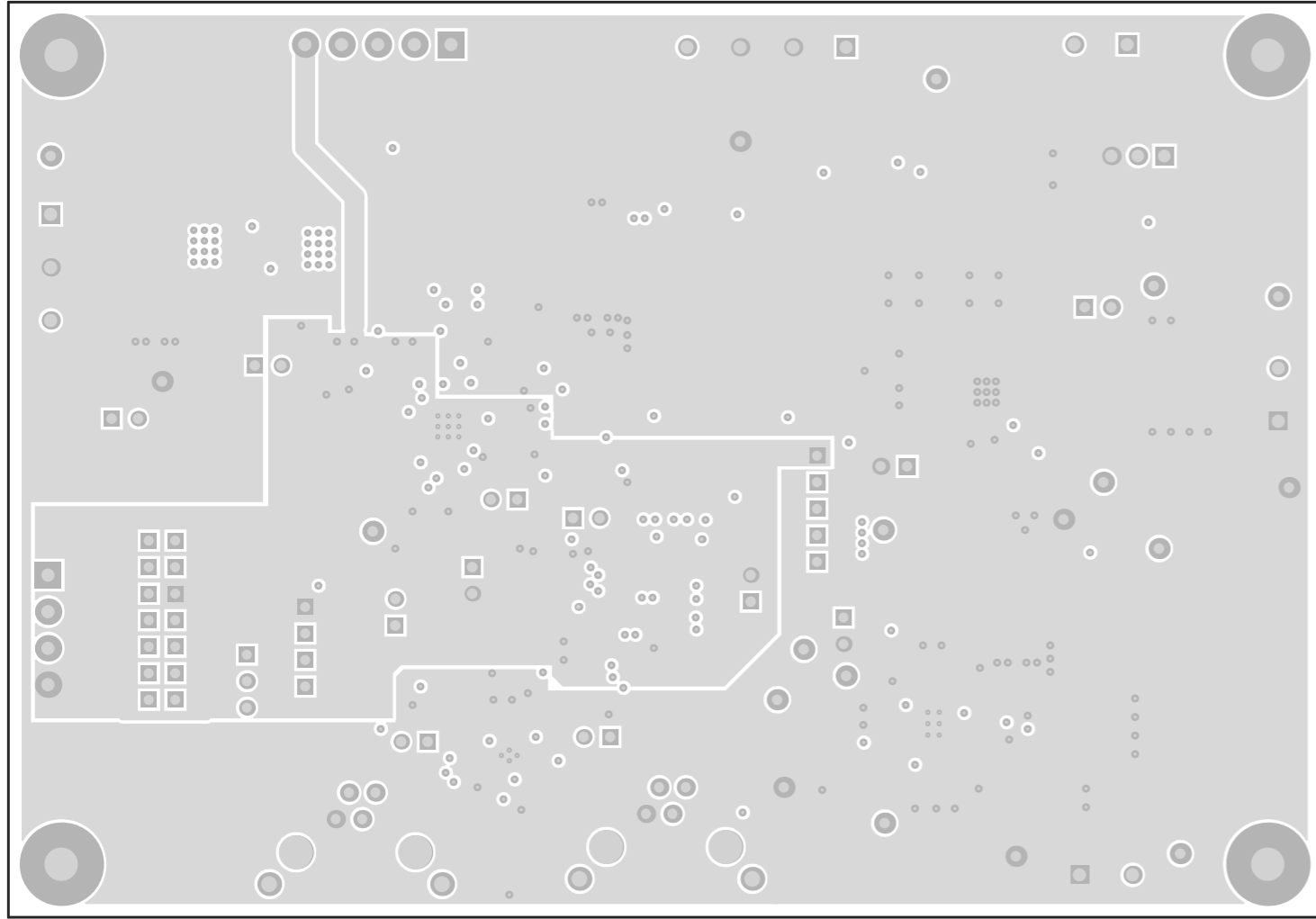


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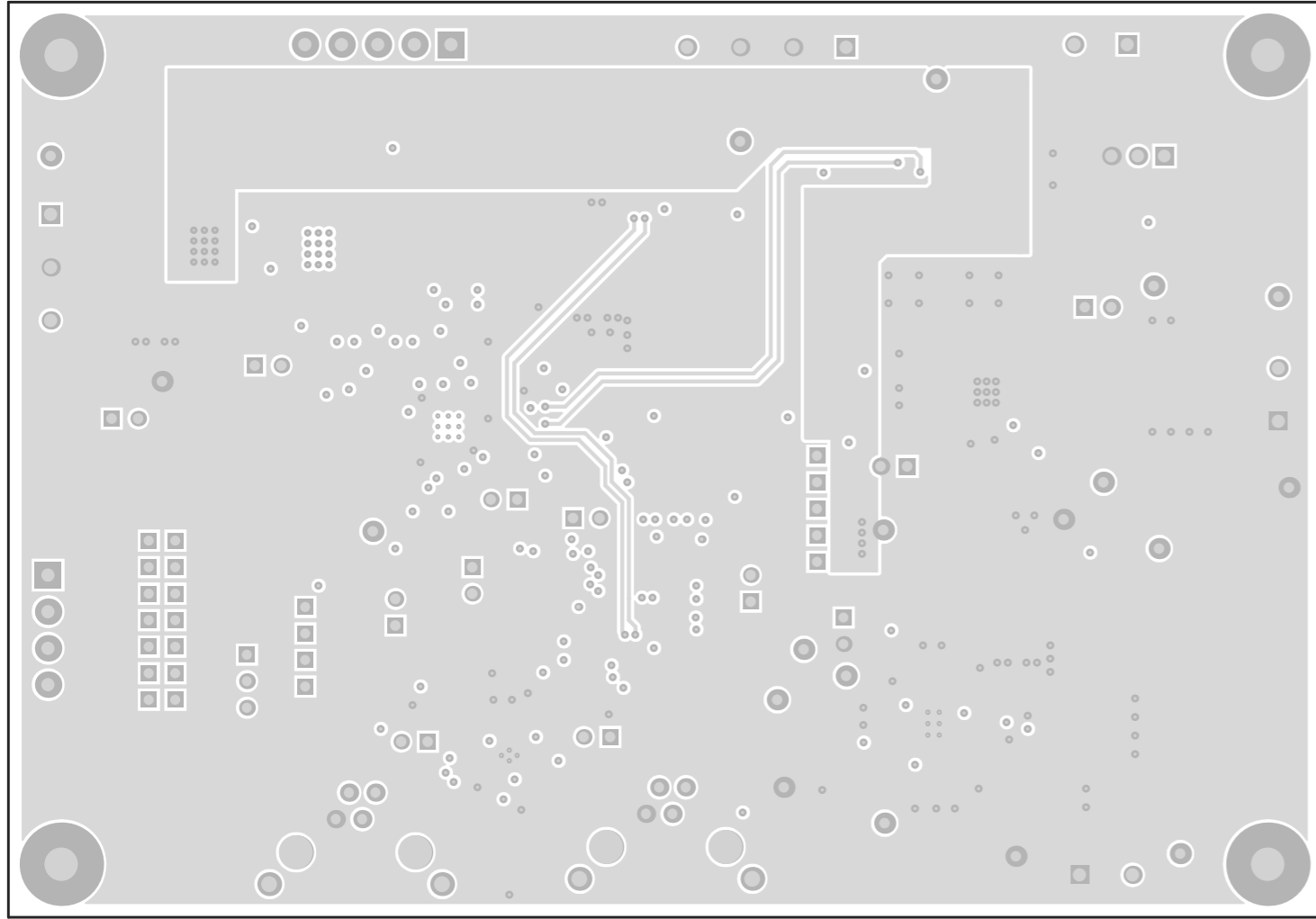
| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP9668 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Top Solder | | | |
| PLOT NAME = Top Solder Mask | GENERATED : 5/6/2014 12:58:42 PM | TEXAS INSTRUMENTS | |



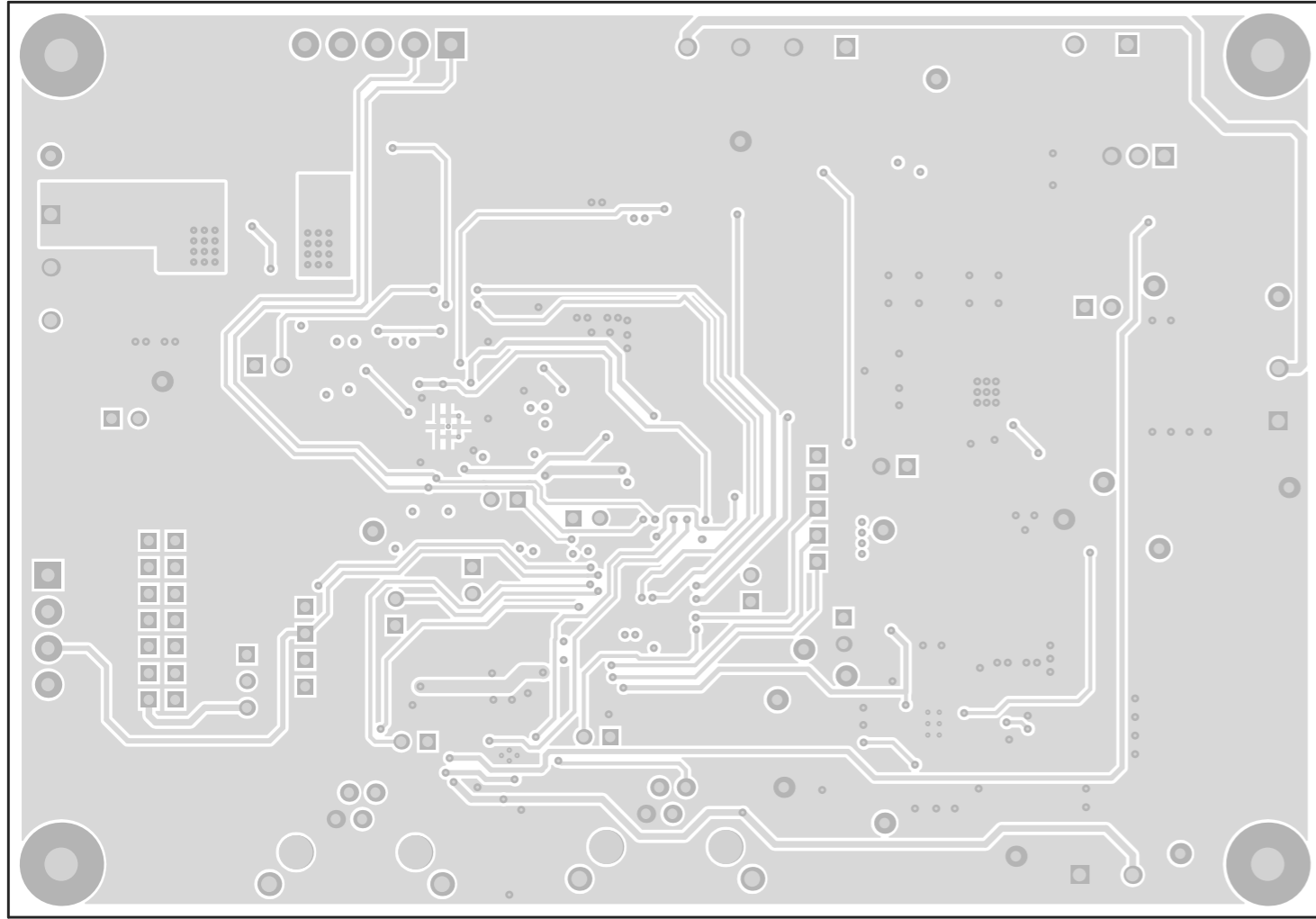
| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP9668 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Top Layer | | | |
| PLOT NAME = Top Layer | GENERATED : 5/6/2014 12:58:43 PM | TEXAS INSTRUMENTS | |



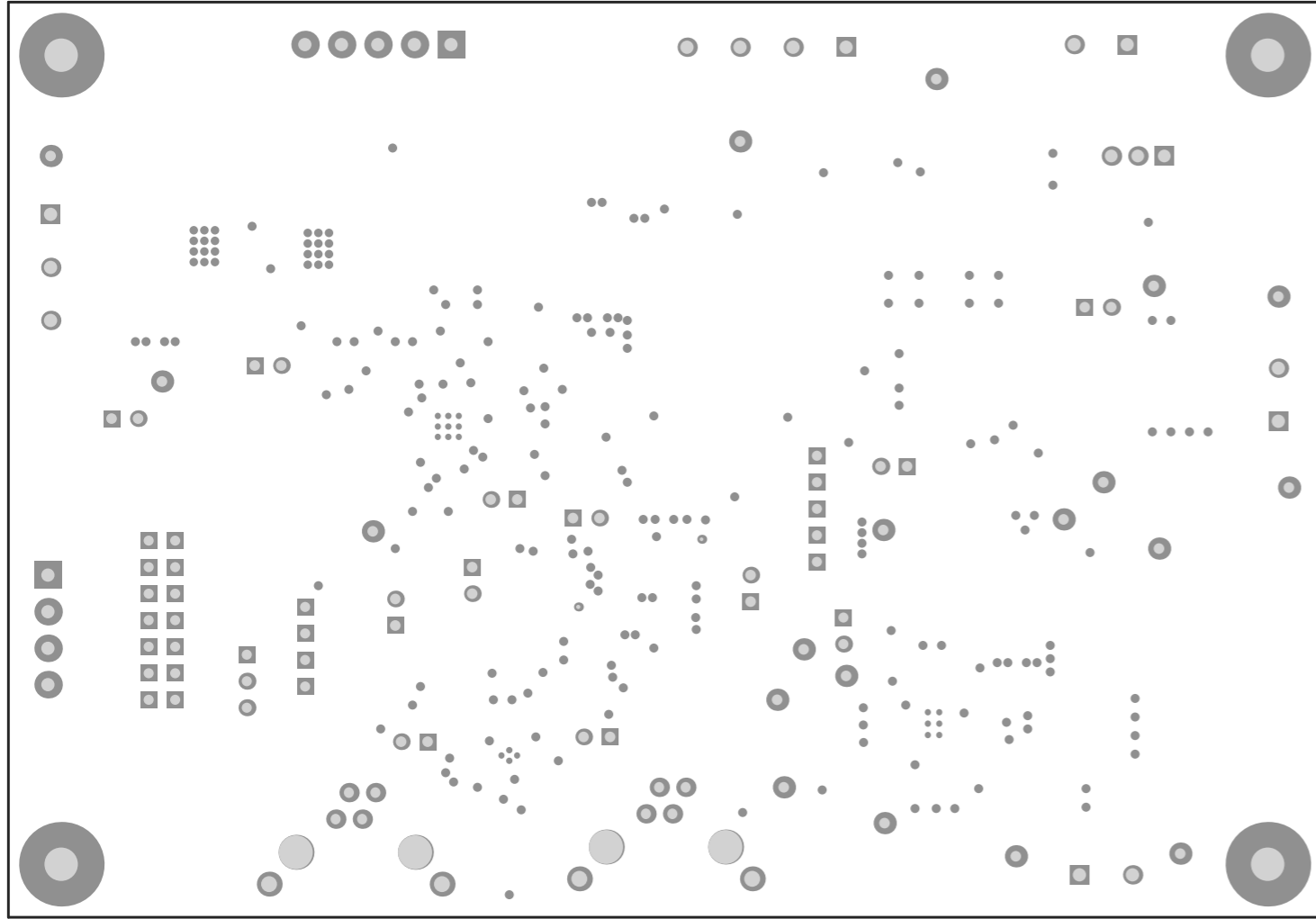
| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP9668 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = | | | |
| PLOT NAME = MidLayer1 | GENERATED : 5/6/2014 12:58:44 PM | TEXAS INSTRUMENTS | |



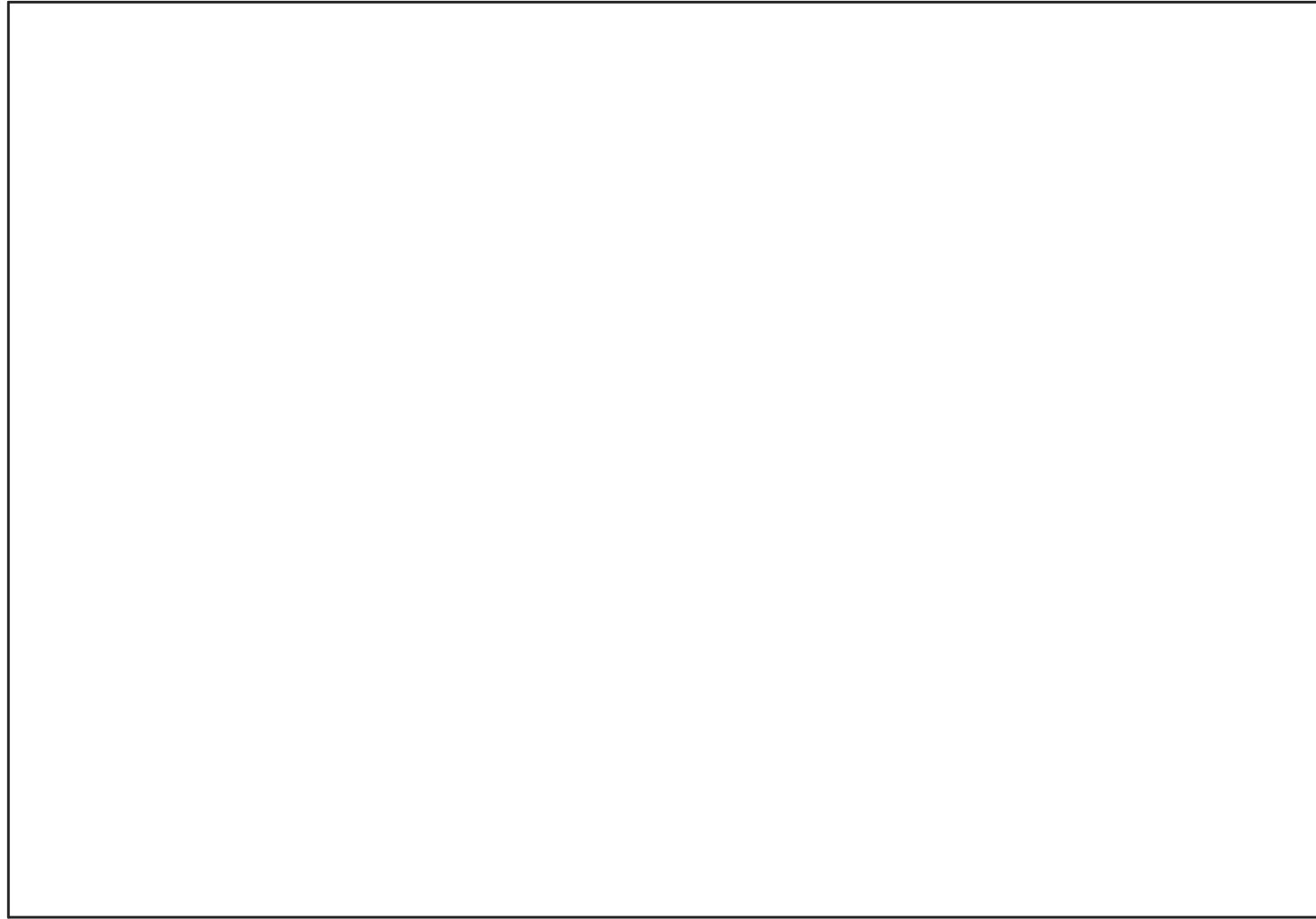
| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP9668 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = | | | |
| PLOT NAME = MidLayer2 | GENERATED : 5/6/2014 12:58:44 PM | TEXAS INSTRUMENTS | |



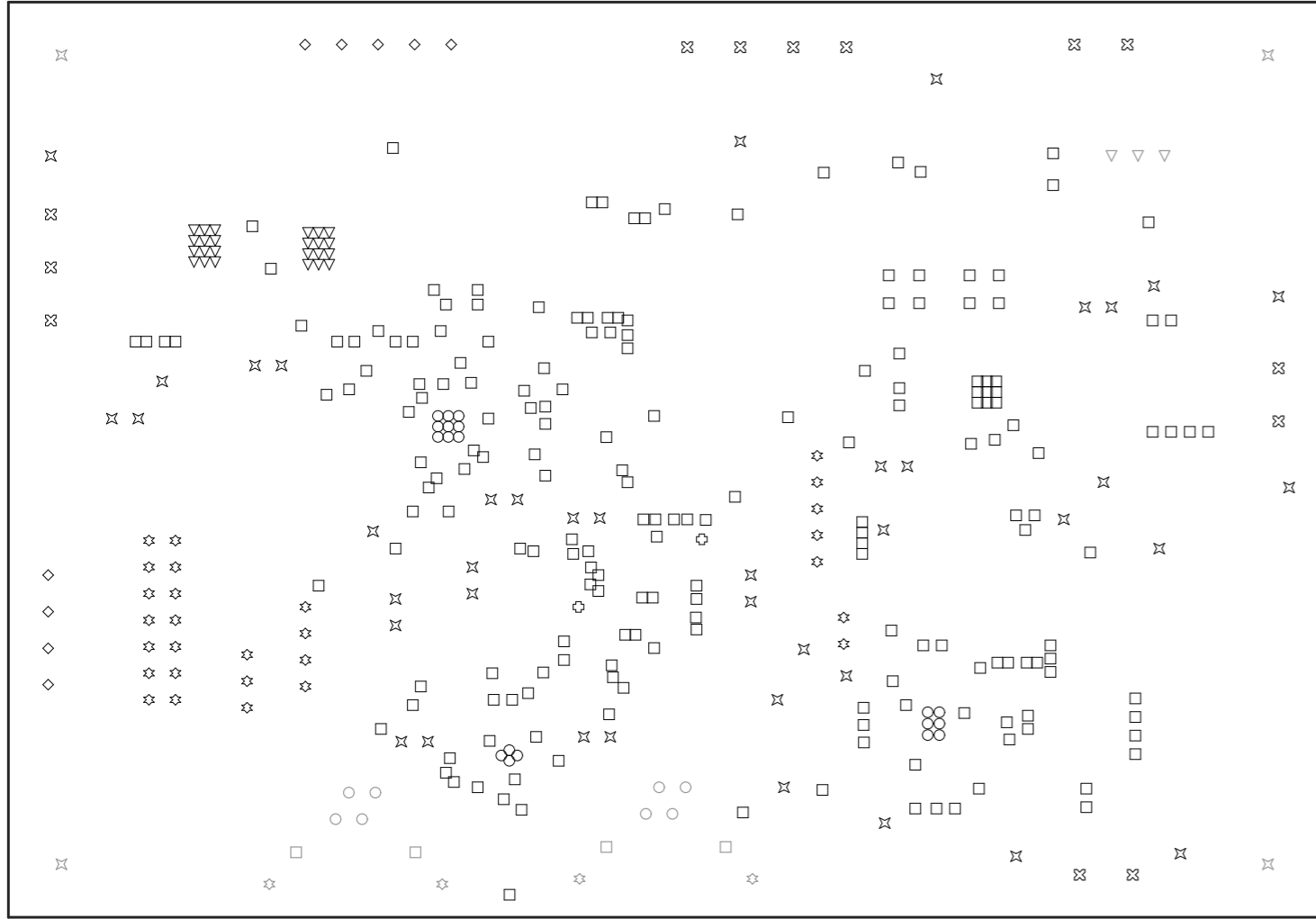
| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP9668 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Bottom Layer | | | |
| PLOT NAME = Bottom Layer | GENERATED : 5/6/2014 12:58:45 PM | TEXAS INSTRUMENTS | |



| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP9668 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Bottom Solder | | | |
| PLOT NAME = Bottom Solder Mask | GENERATED : 5/6/2014 12:58:45 PM | TEXAS INSTRUMENTS | |



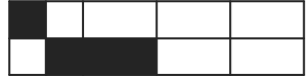
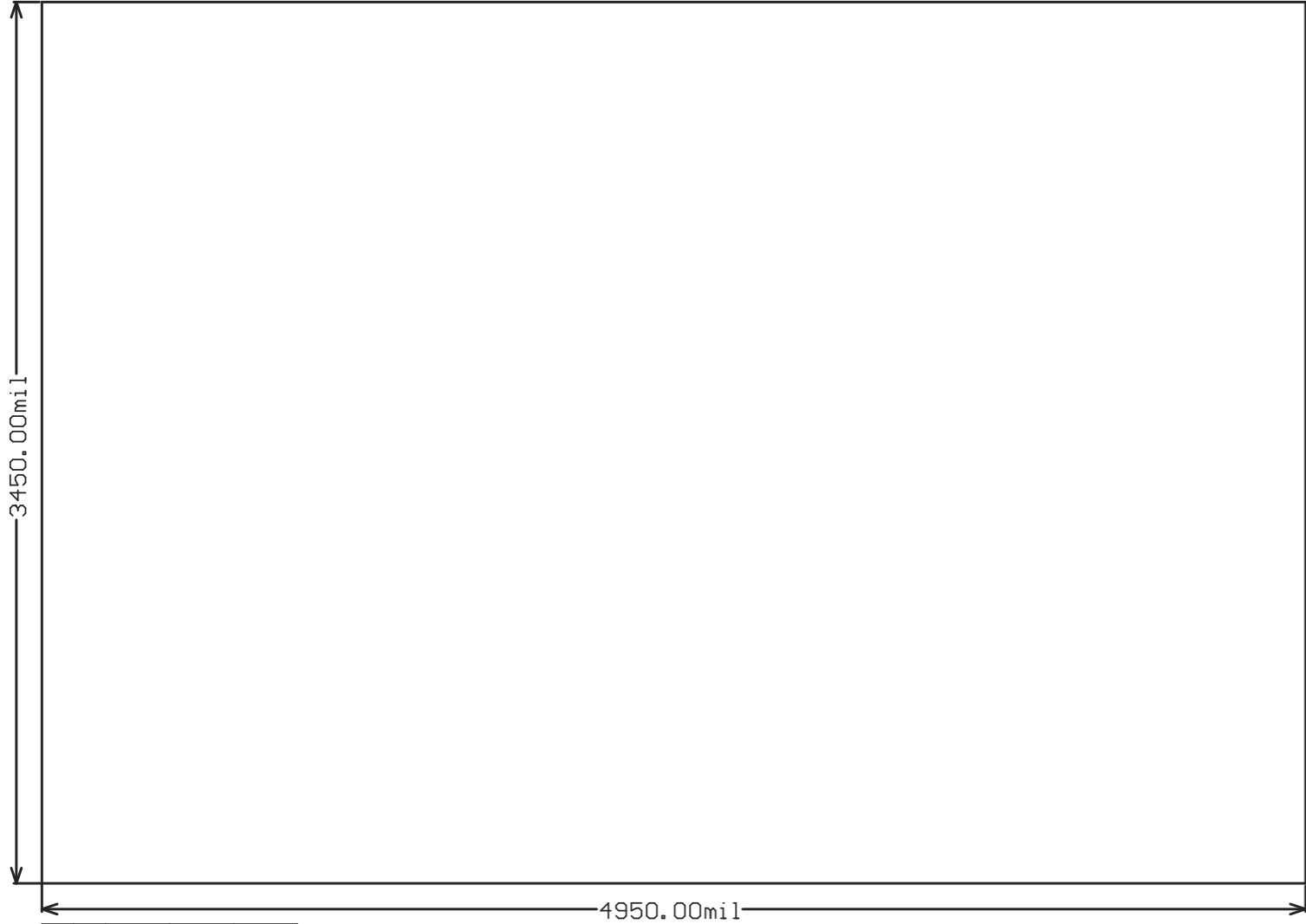
| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP9668 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Bottom Overlay | | | |
| PLOT NAME = Bottom Overlay | GENERATED : 5/6/2014 12:58:46 PM | TEXAS INSTRUMENTS | |



| Symbol | Hit Count | Tool Size | Plated | Hole Type |
|--------|------------------|--------------------|--------|-----------|
| ○ | 19 | 7.874mil (0.2mm) | PTH | Round |
| ▽ | 24 | 8mil (0.203mm) | PTH | Round |
| □ | 198 | 12mil (0.305mm) | PTH | Round |
| ⊕ | 2 | 15mil (0.381mm) | PTH | Round |
| ☆ | 28 | 38mil (0.965mm) | PTH | Round |
| ○ | 8 | 39mil (0.991mm) | PTH | Round |
| ✕ | 41 | 40mil (1.016mm) | PTH | Round |
| ▽ | 3 | 47mil (1.194mm) | PTH | Round |
| ⊗ | 13 | 49.213mil (1.25mm) | PTH | Round |
| ◇ | 9 | 50mil (1.27mm) | PTH | Round |
| ☆ | 4 | 60mil (1.524mm) | PTH | Round |
| ✕ | 4 | 125.984mil (3.2mm) | PTH | Round |
| □ | 4 | 128mil (3.251mm) | NPTH | Round |
| | 357 Total | | | |

Drill Table

| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP9668 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Drill Drawing | | | |
| PLOT NAME = Drill Drawing | GENERATED : 5/6/2014 12:58:46 PM | TEXAS INSTRUMENTS | |



1000 (mil)

| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP9668 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = M2 Board Dimensions | | | |
| PLOT NAME = Board Dimensions | GENERATED : 5/6/2014 12:58:47 PM | TEXAS INSTRUMENTS | |

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